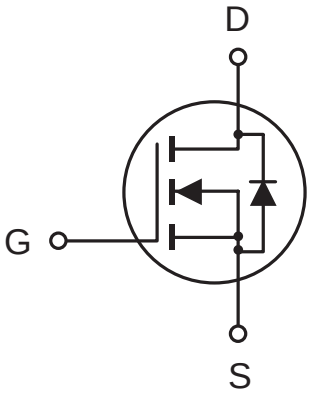
CED71A3/CEU71A3

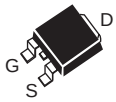
Dec. 2002

N-Channel Logic Level Enhancement Mode Field Effect Transistor

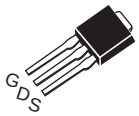
FEATURES

- 30V , 65A , $R_{DS(ON)}$=10mΩ @V_{GS}=10V.
  $R_{DS(ON)}$=14mΩ @V_{GS}=5.0V.
- Super high dense cell design for extremely low $R_{DS(ON)}$.
- High power and current handling capability.
- TO-252 & TO-251 package.





CEU SERIES
TO-252AA(D-PAK)



CED SERIES
TO-251(I-PAK)

ABSOLUTE MAXIMUM RATINGS (Tc=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	±20	V
Drain Current-Continuous	I_D	65	A
-Pulsed	I_{DM}	100	A
Drain-Source Diode Forward Current	I_S	65	A
Maximum Power Dissipation @Tc=25°C	P_D	69	W
Derate above 25°C		0.56	W/°C
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to 150	°C

THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.8	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	40	°C/W

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ELECTRICAL CHARACTERISTICS (T_C=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS} = 0V, I_D = 250μA	30			V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 30V, V_{GS} = 0V			1	μA
Gate-Body Leakage	I_{GSS}	V_{GS} = ±20V, V_{DS} = 0V			±100	nA
ON CHARACTERISTICS[a]						
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250μA	1		3	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	V_{GS} = 10V, I_D = 15A		8.5	10	mΩ
		V_{GS} = 5.0V, I_D = 13A		11.5	14	mΩ
On-State Drain Current	$I_{D(ON)}$	V_{GS} = 10V, V_{DS} = 5V	65			A
Forward Transconductance	g_{FS}	V_{DS} = 5V, I_D = 12A		26		S
DYNAMIC CHARACTERISTICS[b]						
Input Capacitance	C_{ISS}	V_{DS} =15V, V_{GS} = 0V f =1.0MHz		2152		pF
Output Capacitance	C_{OSS}			965		pF
Reverse Transfer Capacitance	C_{RSS}			234		pF
SWITCHING CHARACTERISTICS[b]						
Turn-On Delay Time	$t_{D(ON)}$	V_{DD} = 15V, I_D =1A, V_{GS} = 10V, R_{GEN} =6Ω		30	60	ns
Rise Time	t_r			63	110	ns
Turn-Off Delay Time	$t_{D(OFF)}$			73	130	ns
Fall Time	t_f			59	100	ns
Total Gate Charge	Q_g	V_{DS} =10V, I_D = 15A, V_{GS} =10V		55	67	nC
Gate-Source Charge	Q_{gs}			9		nC
Gate-Drain Charge	Q_{gd}			18		nC

ELECTRICAL CHARACTERISTICS (T_C=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
DRAIN-SOURCE DIODE CHARACTERISTICS [a]						
Diode Forward Voltage	V_{SD}	V_{GS} = 0V, Is = 2.3A		0.9	1.3	V

Notes

a.Pulse Test:Pulse Width≤300 μs, Duty Cycle≤ 2%.

b.Guaranteed by design, not subject to production testing.

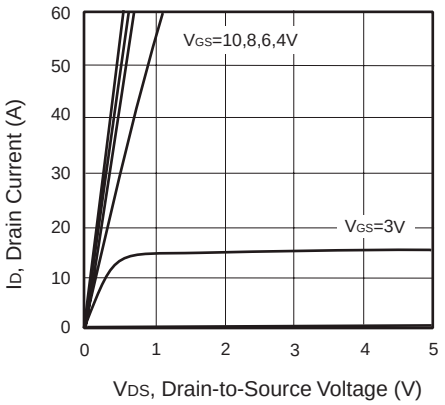

Figure 1. Output Characteristics

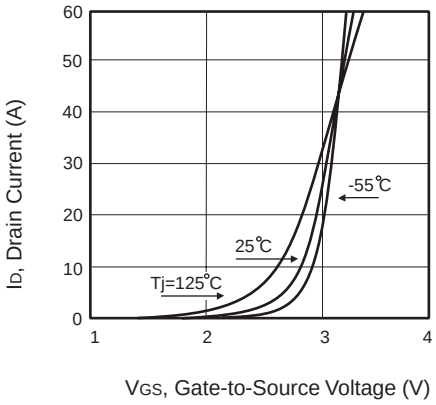

Figure 2. Transfer Characteristics

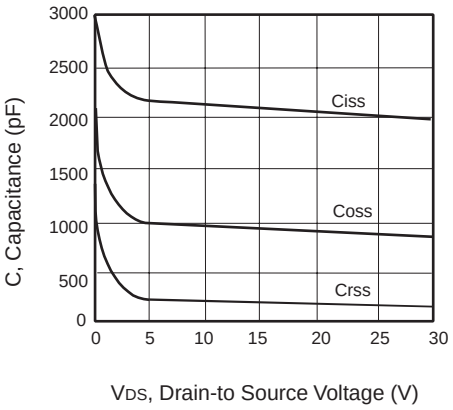

Figure 3. Capacitance

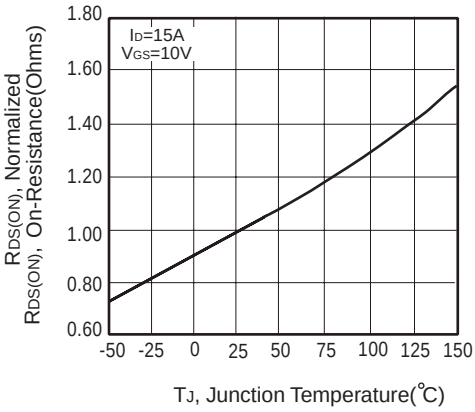

Figure 4. On-Resistance Variation with Temperature

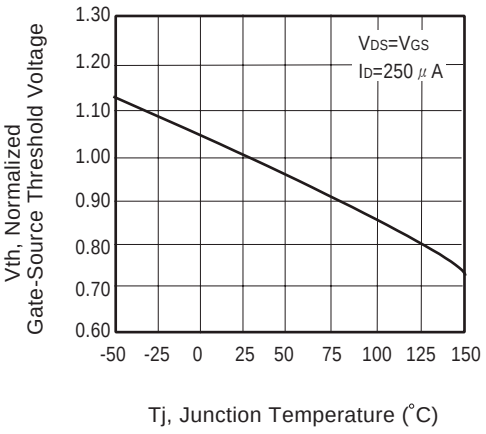

Figure 5. Gate Threshold Variation with Temperature

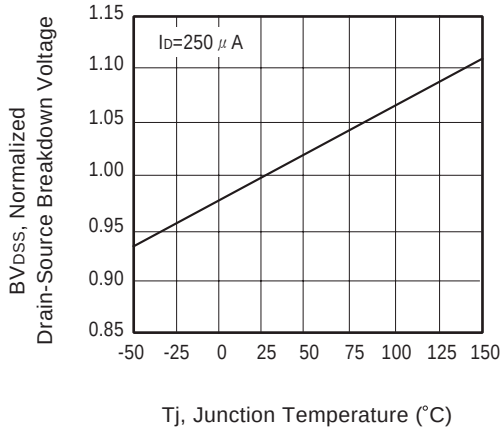

Figure 6. Breakdown Voltage Variation with Temperature

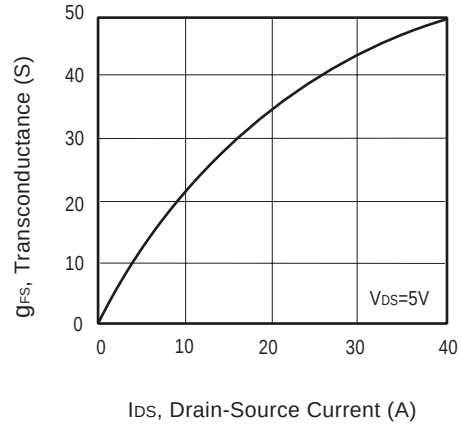

Figure 7. Transconductance Variation with Drain Current

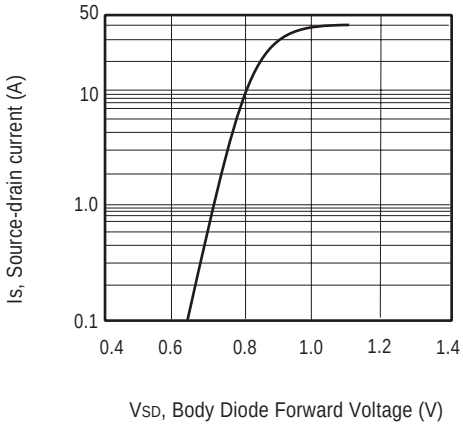

Figure 8. Body Diode Forward Voltage Variation with Source Current

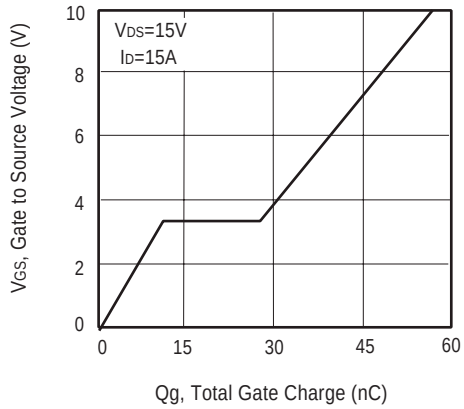

Figure 9. Gate Charge

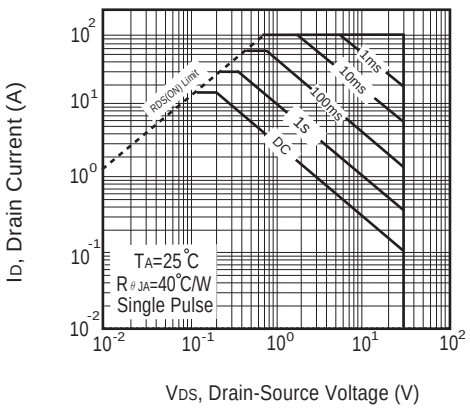

Figure 10. Maximum Safe Operating Area

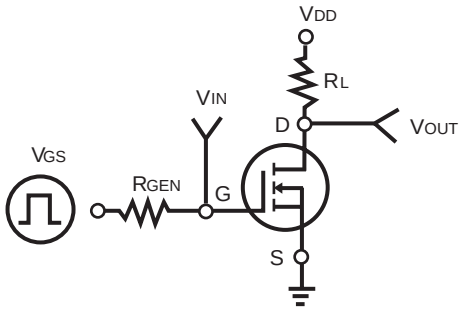

Figure 11. Switching Test Circuit

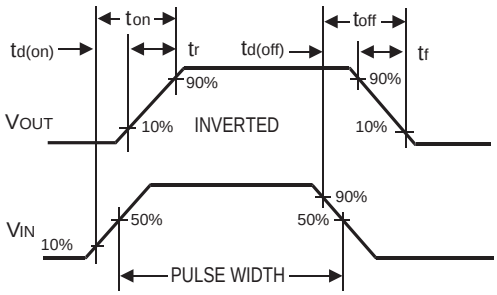

Figure 12. Switching Waveforms

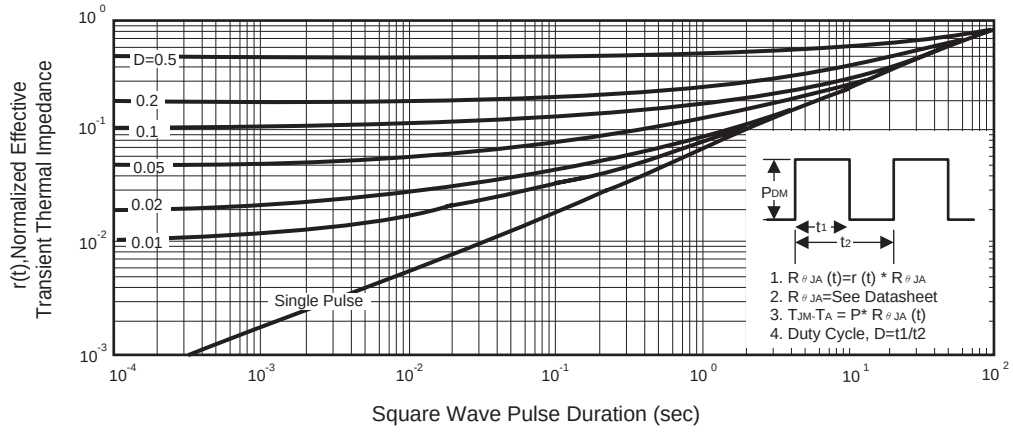

Figure 13. Normalized Thermal Transient Impedance Curve